EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

1206 Package Chip LED(1.1mm Height)

15-21/BHC-XL2M2TY/2T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 15-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

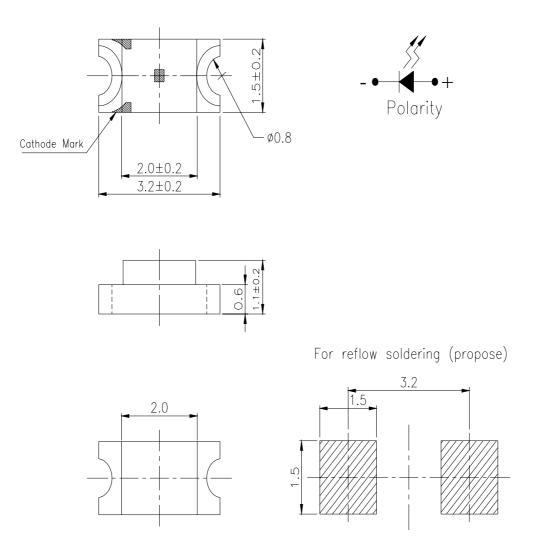
Device Selection Guide

DADT N-		Chip	Lana Calan	
PART No.	Material	Emitted Color	Lens Color	
15-21/BHC-XL2M2TY/2T	InGaN	Blue	Water Clear	





Package Outline Dimensions



Note: Tolerances Unless Dimension is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

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Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	25	mA
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +90	°C
Electrostatic Discharge	ESD	150	V
Power Dissipation	Pd	110	mW
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	100	mA
Soldering Temperature	Tsol	Reflow Soldering : 26 Hand Soldering : 350	

Electro-Optical Characteristics (Ta=25°C)

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	14.5		28.5	mcd	
Viewing Angle	2 0 1/2		140		deg	
Peak Wavelength	λ_{p}		468		nm	
Dominant Wavelength	λd	465		470	nm	IF=5mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		35		nm	
Forward Voltage	$V_{\rm F}$	2.60		3.00	V	
Reverse Current	I _R			50	μA	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Dom. Wavelength

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Group	Bin	Min	Max	Unit	Condition	
А	A9	464.5	467.5			
	A10	467.5	470.5		T C A	
	A11	470.5	473.5	nm	IF=5mA	
	A12	473.5	476.5			

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
L2	14.5	18.0			
M1	18.0	22.5	mcd	IF=5mA	
M2	22.5	36.0			

Bin Rang Of Luminous Voltage

Group	Bin	Min	Max	Unit	Condition	
Т	28	2.60	2.70			
	29	2.70	2.80	T 7	IF =5mA	
	30	2.80	2.90	V		
	31	2.90	3.00			

Notes:

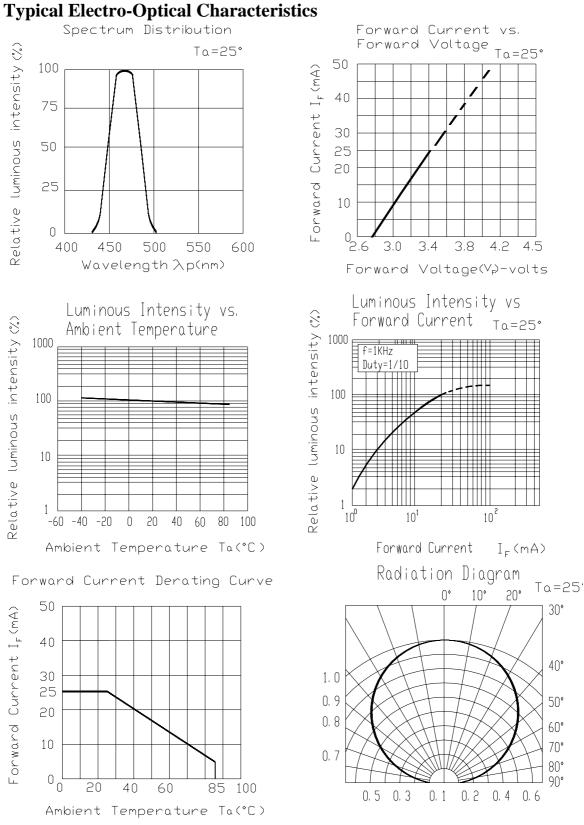
1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

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15-21/BHC-XL2M2TY/2T



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Everlight Electronics Co., Ltd. Device No: SZDSE-151-B08

Rev 1 Page: 5 of 10 Prepared by: Zhang Cheng

Label explanation

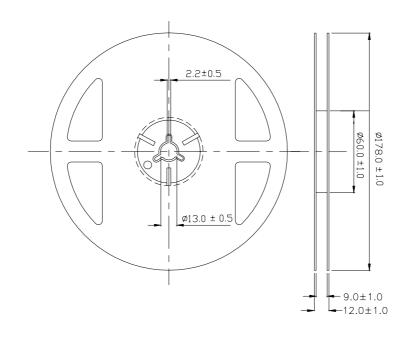
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

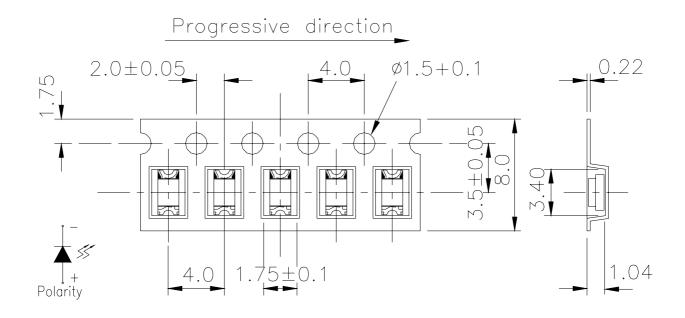


Reel Dimensions



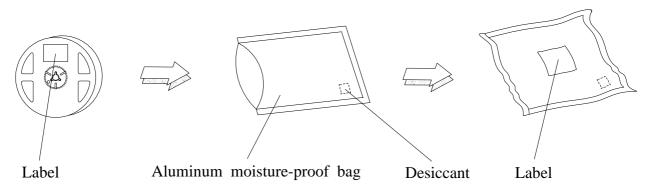
Note: Tolerances Unless Dimension is ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: Tolerances Unless Dimension is ± 0.1 mm , Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

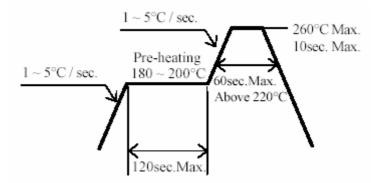
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
б	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

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